3.4mm RIGHT ANGLE LED INDICATOR

Part Number: WP138A8QMP/GD/TG Green

Features

- Surface mount type.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Package:1000pcs / reel.
- Moisture sensitivity level : level 3.
- Housing UL rating:94V-0.
- Housing material: PPA.
- High temperature resistant housing.
- High glass transition temperature epoxy.
- RoHS compliant.

Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



SPEC NO: DSAF4747 APPROVED: Wynec REV NO: V.10B CHECKED: Allen Liu DATE: AUG/18/2016 DRAWN: L.T.Zhang PAGE: 1 OF 6 ERP: 1102000491

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mo @ 10		Viewing Angle [1]
	. . ,		Min.	Тур.	201/2
WP138A8QMP/GD/TG	Green (GaP)	Green Diffused	6	12	40°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%

3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Typ. Max.		Units	Test Conditions	
λpeak	Peak Wavelength	Green	565		nm	IF=10mA	
λD [1]	Dominant Wavelength	Green	568		nm	IF=10mA	
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=10mA	
С	Capacitance	Green	15		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Green	2.0	2.5	V	IF=10mA	
lr	Reverse Current	Green		10	uA	VR = 5V	

Notes:

1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units	
Power dissipation	62.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



WP138A8QMP/GD/TG

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units : mm)



APPROVED: Wynec

CHECKED: Allen Liu

DRAWN: L.T.Zhang

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PRECAUTIONS

1.A moisture barrier bag (MBB) containing LEDs shall be kept in an environment with temperature below 40°C and humidity below 90% RH.

A MBB shall be kept sealed until the LEDs contained in that bag are to be used immediately. Storge in an environment with temperature $5\sim30^{\circ}$ C and humidity below 60% RH.

- 2.After a MBB has been opened, all LEDs contained in that bag shall complete soldering process within according to the conditions listed on the Kingbright MBB.
- 3.If the 10% spot of a humidity indicator card (HIC) indicates wet, LEDs shall be baked according to the conditions listed on the Kingbright MBB.
- 4.During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



5. The tip of the soldering iron should never touch the lens epoxy.

- 6.After soldering, allow at least three minutes for the component to cool down to room temperature before further operations.
- 7.If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 8 Recommended Reflow Soldering Profiles For SMD Housing LEDs



- maximum soldering temperature should be limited to 260° (2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Recommended Solder: Sn/Cu/Ag.
- 4.No more than once.